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COMPLIANT

Vishay Siliconix

N-Channel 30-V (D-S) MOSFET

PRODUCT SUMMARY						
V _{DS} (V)	R _{DS(on)} (Ω)	I _D (A) ^a	Q _g (Typ.)			
30	0.0039 at V _{GS} = 10 V	30.5	21.5 nC			
30	0.0055 at V _{GS} = 4.5 V	25.6	21.5110			

SO-8

8 D

7

6

D

D

5 D

S

S

S

G

2

3

4



- Halogen-free
- TrenchFET[®] Power MOSFET
- + 100 $\%~{\rm R_g}$ and UIS Tested

APPLICATIONS

- Low-Side DC/DC Conversion
 - Notebook PC
 - Gaming



Ordering Information: Si4166DY-T1-GE3 (Lead (Pb)-free and Halogen-free)

Top View

N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS $T_A = 25 \degree C$, unless otherwise noted						
Parameter		Symbol	Limit	Unit		
Drain-Source Voltage		V _{DS}	30	V		
Gate-Source Voltage		V _{GS}	± 20			
	T _C = 25 °C		30.5			
Continuous Drain Current (T. – 150 °C)	T _C = 70 °C	I _D	24.5			
	T _A = 25 °C		20.5 ^{b, c}			
	T _A = 70 °C		16.5 ^{b, c}	^		
Pulsed Drain Current		I _{DM}	70	~		
Continuous Source Drain Diade Current	T _C = 25 °C	la	5.9			
Continuous Source-Drain Diode Current	T _A = 25 °C	'S	2.7 ^{b, c}			
Single Pulse Avalanche Current		I _{AS}	30			
Avalanche Energy		E _{AS}	45	mJ		
	T _C = 25 °C		6.5			
Maximum Power Dissination	T _C = 70 °C	P _D	4.2	\W/		
	T _A = 25 °C		3.0 ^{b, c}			
	T _A = 70 °C]	1.9 ^{b, c}			
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150	°C		

THERMAL RESISTANCE RATINGS						
Parameter	Symbol	Typical	Maximum	Unit		
Maximum Junction-to-Ambient ^{b, d}	t ≤ 10 s	R _{thJA}	34	41	°C/W	
Maximum Junction-to-Foot (Drain)	Steady State	R _{thJF}	15	19	0/10	

Notes:

a. Based on $T_C = 25 \ ^{\circ}C$.

b. Surface Mounted on 1" x 1" FR4 board.

c. t = 10 s.

d. Maximum under Steady State conditions is 80 °C/W.



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SPECIFICATIONS T _J = 25 °C, unless otherwise noted							
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 V, I_{D} = 250 \mu A$	30			V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	L = 250 µA		31		mV/°C	
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	- 1 _D = 250 μA		- 5.4			
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$	1.2		2.4	V	
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA	
Zero Gate Voltage Drain Current	وعما	V _{DS} = 30 V, V _{GS} = 0 V			1	μA	
	USS	$V_{DS} = 30$ V, $V_{GS} = 0$ V, $T_{J} = 55$ °C			10		
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \geq 5$ V, V_{GS} = 10 V	30			А	
Drain Source On State Basistance ⁸	Brach	$V_{GS} = 10 \text{ V}, I_D = 15 \text{ A}$		0.0032	0.0039)39	
Diam-Source On-State Resistance	· DS(on)	$V_{GS} = 4.5 \text{ V}, I_{D} = 10 \text{ A}$		0.0045	0.0055	32	
Forward Transconductance ^a	9 _{fs}	$V_{DS} = 15 \text{ V}, \text{ I}_{D} = 15 \text{ A}$		65		S	
Dynamic ^b							
Input Capacitance	C _{iss}			2730		pF	
Output Capacitance	C _{oss}	V_{DS} = 15 V, V_{GS} = 0 V, f = 1 MHz		540			
Reverse Transfer Capacitance	C _{rss}			205			
Total Gate Charge	Qg	$V_{DS} = 15 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 10 \text{ A}$		42.5	65	nC	
Gate-Source Charge	Q _{as}	V _{DS} = 15 V, V _{GS} = 4.5 V, I _D = 10 A		6.9			
Gate-Drain Charge	Q _{qd}			7.1			
Gate Resistance	R _g	f = 1 MHz	0.2	0.8	1.6	Ω	
Turn-On Delay Time	t _{d(on)}			30	50		
Rise Time	t _r	V _{DD} = 15 V, R _L = 1.5 Ω		19	35	-	
Turn-Off Delay Time	t _{d(off)}	${ m I}_{ m D}\cong$ 10 A, ${ m V}_{ m GEN}$ = 4.5 V, ${ m R}_{ m g}$ = 1 Ω		35	60		
Fall Time	t _f	1		15	30		
Turn-On Delay Time	t _{d(on)}			12	24	ns	
Rise Time	t _r	V_{DD} = 15 V, R_L = 1.5 Ω		9	18	-	
Turn-Off Delay Time	t _{d(off)}	$I_D \cong 10 \text{ A}, V_{GEN} = 10 \text{ V}, \text{ R}_g = 1 \Omega$		29	50		
Fall Time	t _f			9	18		
Drain-Source Body Diode Characteristi	cs						
Continuous Source-Drain Diode Current	۱ _S	T _C = 25 °C			5.9	٨	
Pulse Diode Forward Current ^a	I _{SM}				70		
Body Diode Voltage	V _{SD}	I _S = 3 A		0.74	1.1	V	
Body Diode Reverse Recovery Time	t _{rr}			28	55	ns	
Body Diode Reverse Recovery Charge	Q _{rr}	= 10.4 dl/dt = 100.4/up T = 25.00		21	42	nC	
Reverse Recovery Fall Time	t _a	$I_F = 10 \text{ A}, \text{ dl/dt} = 100 \text{ A/}\mu\text{s}, T_J = 25 \text{ °C}$		15			
Reverse Recovery Rise Time	t _b]		13		ns	

Notes:

a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %

b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.





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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted







Capacitance



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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted





On-Resistance vs. Gate-to-Source Voltage









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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



* The power dissipation P_D is based on $T_{J(max)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Foot

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see http://www.vishay.com/ppg?68953.



Package Information

Vishay Siliconix

SOIC (NARROW): 8-LEAD JEDEC Part Number: MS-012





	MILLIM	IETERS	INCHES		
DIM	Min	Мах	Min	Мах	
А	1.35	1.75	0.053	0.069	
A ₁	0.10	0.20	0.004	0.008	
В	0.35	0.51	0.014	0.020	
С	0.19	0.25	0.0075	0.010	
D	4.80	5.00	0.189	0.196	
E	3.80	4.00	0.150	0.157	
е	1.27	BSC	0.050 BSC		
Н	5.80	6.20	0.228	0.244	
h	0.25	0.50	0.010	0.020	
L	0.50	0.93	0.020	0.037	
q	0°	8°	0°	8°	
S	0.44	0.64	0.018	0.026	
ECN: C-06527-Rev. I, 11-Sep-06 DWG: 5498					

Application Note 826

Vishay Siliconix



RECOMMENDED MINIMUM PADS FOR SO-8



Recommended Minimum Pads Dimensions in Inches/(mm)

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